

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT								
NATURE OF CONVEYANCE:	ASSIGNMENT								
CONVEYING PARTY DATA									
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Chih-Kai Hu</td> <td>04/09/2013</td> </tr> <tr> <td>Yu-Jing Liao</td> <td>04/09/2013</td> </tr> <tr> <td>I-Cheng Chuang</td> <td>04/09/2013</td> </tr> </tbody> </table>		Name	Execution Date	Chih-Kai Hu	04/09/2013	Yu-Jing Liao	04/09/2013	I-Cheng Chuang	04/09/2013
Name	Execution Date								
Chih-Kai Hu	04/09/2013								
Yu-Jing Liao	04/09/2013								
I-Cheng Chuang	04/09/2013								
RECEIVING PARTY DATA									
Name:	HTC Corporation								
Street Address:	No.23, Xinghua Rd., Taoyuan City								
City:	Taoyuan County								
State/Country:	TAIWAN								
Postal Code:	330								
PROPERTY NUMBERS Total: 1									
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13863389</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13863389				
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Application Number:	13863389								
CORRESPONDENCE DATA									
Fax Number:	5105807280								
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>									
Email:	USA@JCIPGROUP.COM.TW								
Correspondent Name:	JIANQ CHYUN INTELLECTUAL PROPERTY OFFICE								
Address Line 1:	7F.-1, NO. 100, ROOSEVELT RD., SEC. 2,								
Address Line 4:	TAIPEI, TAIWAN 100								
ATTORNEY DOCKET NUMBER:	45109-US-PA								
NAME OF SUBMITTER:	Belinda Lee								
Signature:	/Belinda Lee/								
Date:	04/17/2013								
Total Attachments: 2 source=45109_assi#page1.tif source=45109_assi#page2.tif									

CH \$40.00 13863389

ASSIGNMENT

WHEREAS,

1. Chih-Kai Hu
2. Yu-Jing Liao
3. I-Cheng Chuang

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: **MOLDED CASING, MOLD ASSEMBLY AND FORMING METHOD**

Filed: Serial No.

Executed concurrently with the execution of this instrument

WHEREAS, HTC Corporation
of No.23, Xinghua Rd., Taoyuan City, Taoyuan County 330, Taiwan (R.O.C.)

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said rights, title and interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Signature: Chih-Kai Hu Date: 2013/04/09
Sole or First Joint Inventor: Chih-Kai Hu

Signature: Yu-Jing Liao Date: 2013/04/09
Second Joint Inventor (if any): Yu-Jing Liao

Signature: I-Cheng Chuang Date: 2013/4/9
Third Joint Inventor (if any): I-Cheng Chuang